



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

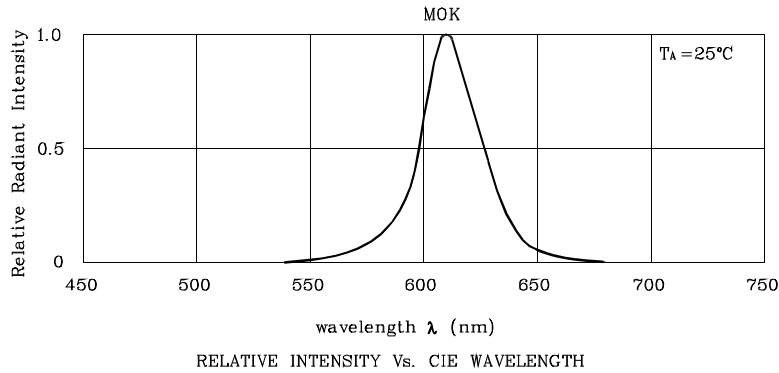
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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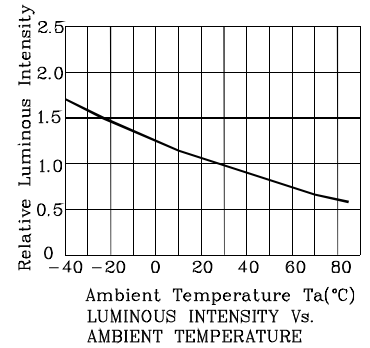
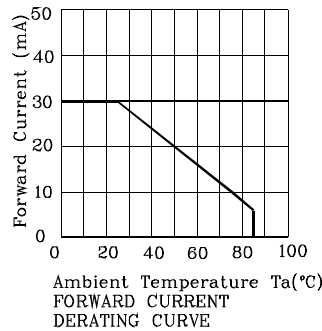
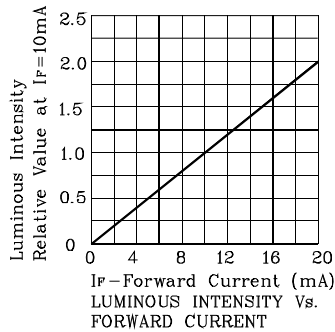
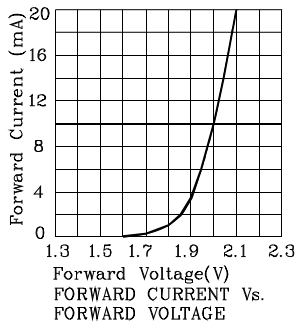
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







❖ MOK



**LED is recommended for reflow soldering and soldering profile is shown below.**

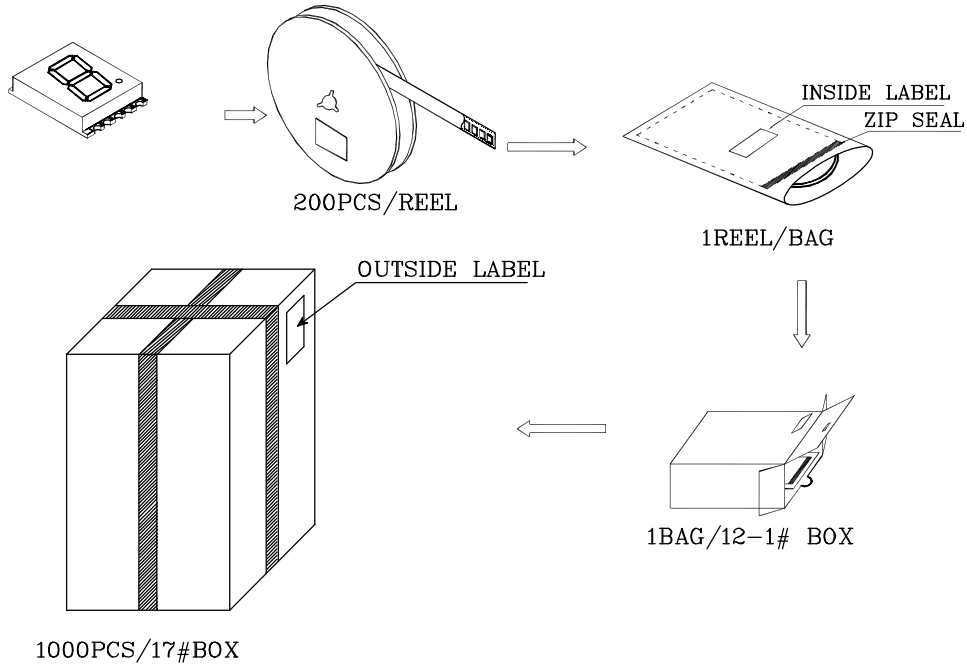
**Reflow Soldering Profile for SMD Products (Pb-Free Components)**



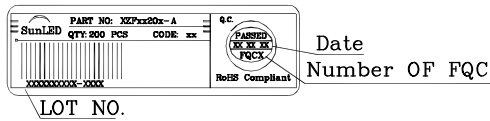
- Notes:
1. Maximum soldering temperature should not exceed 260°C
  2. Recommended reflow temperature: 145°C-260°C
  3. Do not put stress to the epoxy resin during high temperatures conditions



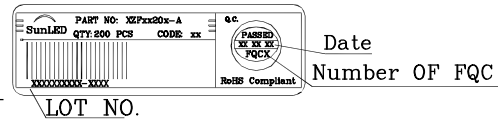
PACKING & LABEL SPECIFICATIONS



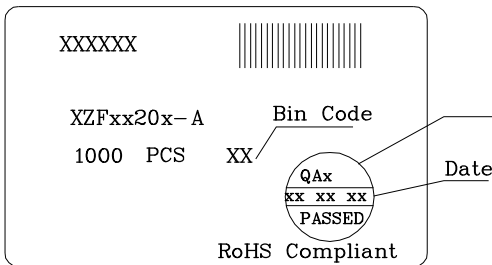
Inside Label On TAPE



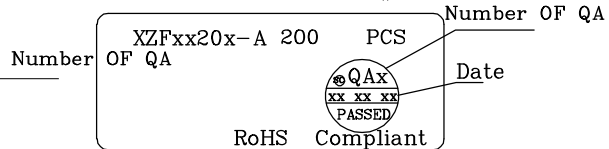
Outside Label On BAG



Outside Label On 19#Box



Outside Label On 12#Box



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